状态

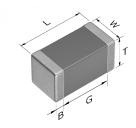
积层贴片陶瓷片式电容器

C1608CH2E821J080AA

RoHS Reach Halogen Free Pb Free

交货型号	C1608CH2E821JT****
用途	一般等级
特点	Mid 中耐压(100~630V)
系列	C1608 [EIA 0603]

量产体制(新设计非推荐)



尺寸		
长度(L)	1.60mm ±0.10mm	
宽度(W)	0.80mm ±0.10mm	
厚度(T)	0.80mm ±0.10mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.30mm Min.	
推荐焊盘布局(PA)	0.70mm to 1.00mm(Flow Soldering)	
]世行。严益·仰/四 (t n/	0.60mm to 0.80mm (Reflow Soldering)	
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)	
推存序益和/n (FD)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)	
1世行丹益仰四(にし)	0.60mm to 0.80mm(Reflow Soldering)	

电气特性		
电容	820pF ±5%	
额定电压	250VDC	
温度特性	CH(0±60ppm/° C)	
Q (Min.)	1000	
绝缘电阻 (Min.)	10000ΜΩ	

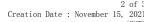
	其他
焊接方法	流体
件按기伍	回流
AEC-Q200	NO
包装形式	纸编带(180mm卷筒)
包装个数	4000pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

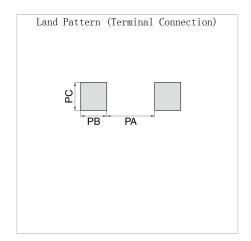
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Associated Images



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